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Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



1.5A, 1000V Fast avalanche Surface Mount Rectifier

FEATURES

- Glass passivated junction chip
- Ideal for automated placement
- Fast switching for high efficiency
- High surge current capability
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21



TYPICAL APPLICATION

The superior avalanche capability of BYG21M is specially suited for free-wheeling, clamping, snubber, demagnetization in power supplies and other power switching applications.

DO-214AC (SMA)

MECHANICAL DATA

Case: DO-214AC (SMA)

Molding compound: UL flammability classification rating 94V-0

Moisture sensitivity level (MSL): level 1, per J-STD-020

Part no. with suffix "H" means AEC-Q101 qualified

Packing code with suffix "G" means green compound (halogen-free)

Terminal: Matte tin plated leads, solderable per JESD22-B102

Meet JESD 201 class 2 whisker test

Polarity: Indicated by cathode band

Weight: 64 mg (approximately)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS (T_A=25°C unless otherwise noted)

PARAMETER	SYMBOL	BYG21M	UNIT
Maximum repetitive peak reverse voltage	V _{RRM}	1000	V
Maximum RMS voltage	V _{RMS}	700	V
Maximum DC blocking voltage	V _{DC}	1000	V
Maximum average forward rectified current	I _{F(AV)}	1.5	A
Peak forward surge current, 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	50	A
Maximum instantaneous forward voltage I _F =1A (Note 1) I _F =1.5A	V _F	1.5 1.6	V
Maximum reverse current @ Rated V _R T _J =25°C T _J =100°C T _J =125°C	I _R	1 10 50	μA
Pulse energy in avalanche mode, non repetitive (Inductive load switch off) T _A =25°C, I _{(BR)R} =1.23A	E _{RSM}	30	mJ
Maximum reverse recovery time (Note 2)	t _{rr}	120	ns
Typical junction capacitance (Note 3)	C _J	13	pF
Typical thermal resistance	R _{θJL}	20	°C/W
	R _{θJA}	70	
Operating junction temperature range	T _J	- 55 to +150	°C
Storage temperature range	T _{STG}	- 55 to +150	°C

Note 1: Pulse test with PW=300μs, 1% duty cycle

Note 2: Test conditions: I_F=0.5A, I_R=1.0A, I_{RR}=0.25A

Note 3: Measured at 1 MHz and applied reverse voltage of 4.0V

ORDERING INFORMATION					
PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX	PACKAGE	PACKING
BYG21M (Note 1)	H	R3	G	SMA	1,800 / 7" Plastic reel
		R2		SMA	7,500 / 13" Paper reel
		M2		SMA	7,500 / 13" Plastic reel
		F3		Folded SMA	1,800 / 7" Plastic reel
		F2		Folded SMA	7,500 / 13" Paper reel
		F4		Folded SMA	7,500 / 13" Plastic reel

Note 1: Whole series with green compound

EXAMPLE					
EXAMPLE PART NO.	PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION
BYG21MHR3G	BYG21M	H	R3	G	AEC-Q101 qualified Green compound

RATINGS AND CHARACTERISTICS CURVES

($T_A=25^{\circ}\text{C}$ unless otherwise noted)

FIG. 1 MAXIMUM AVERAGE FORWARD CURRENT DERATING

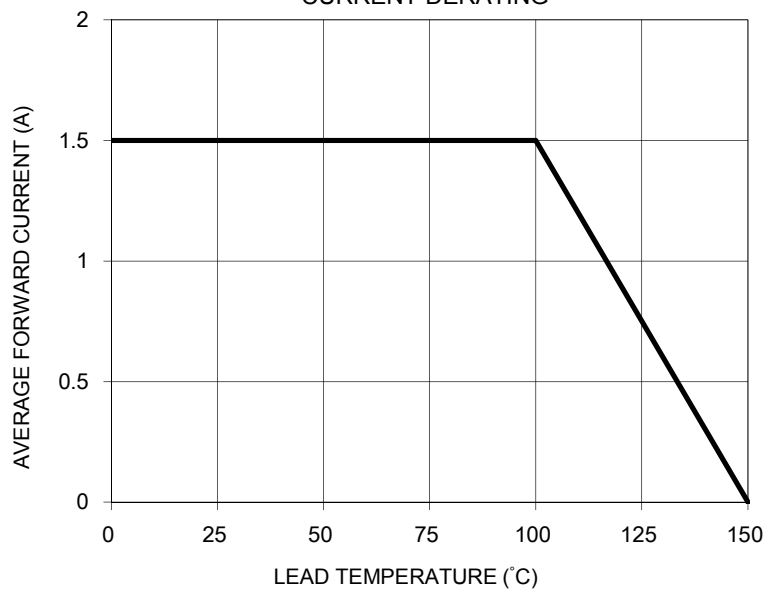


FIG. 2 TYPICAL REVERSE CHARACTERISTICS

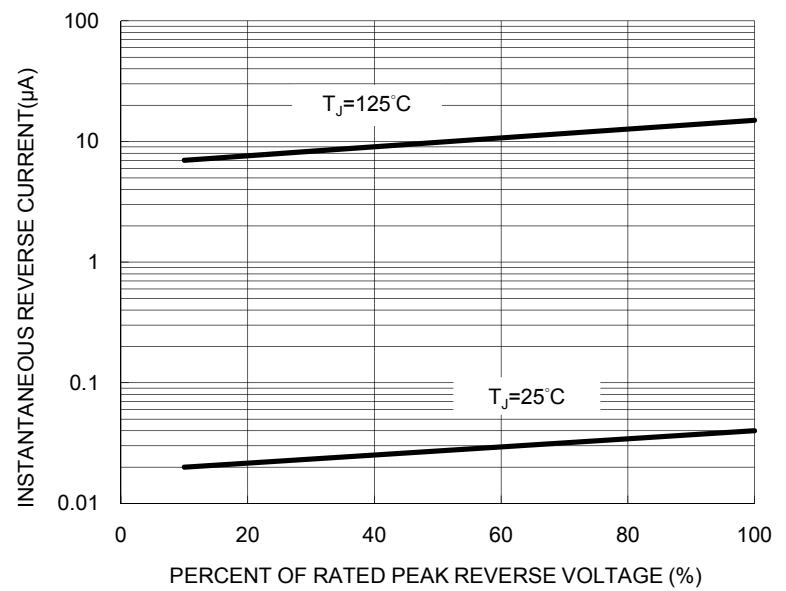


FIG. 3 MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

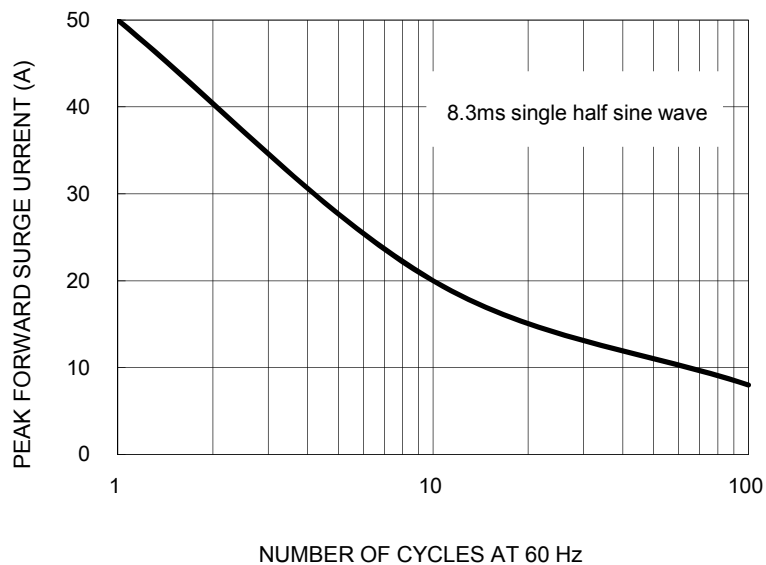


FIG. 4 TYPICAL JUNCTION CAPACITANCE

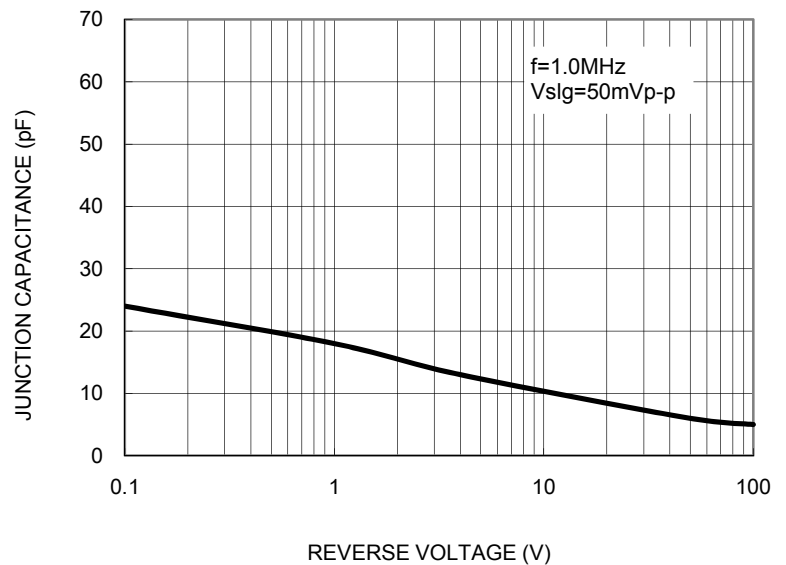
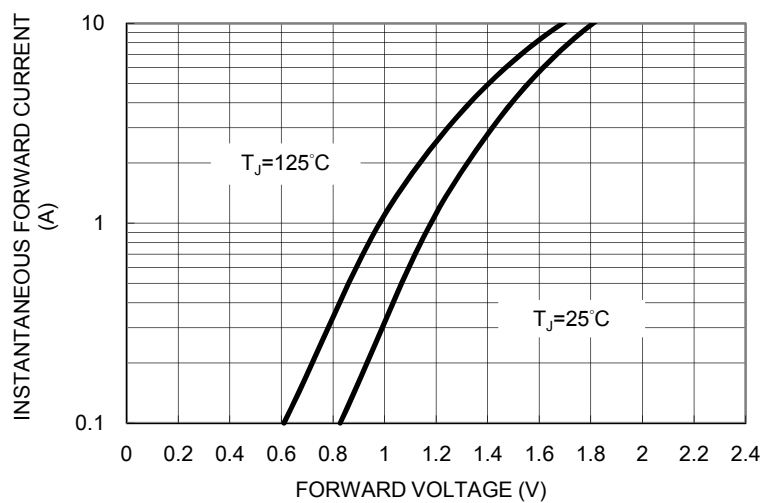
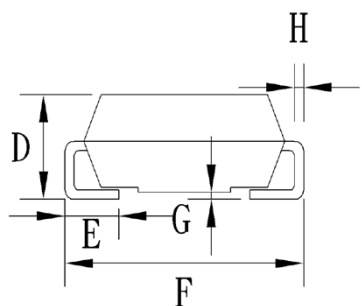
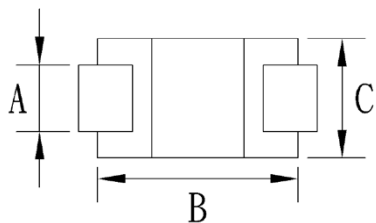


FIG. 5 TYPICAL INSTANTANEOUS
FORWARD CHARACTERISTICS

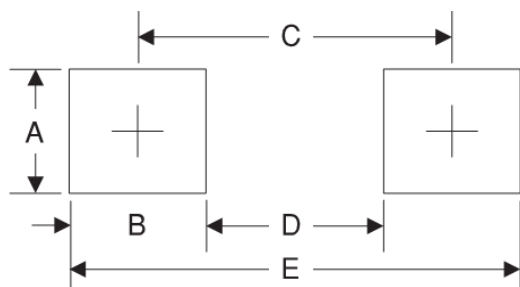


PACKAGE OUTLINE DIMENSIONS
DO-214AC (SMA)



DIM.	Unit (mm)		Unit (inch)	
	Min	Max	Min	Max
A	1.27	1.58	0.050	0.062
B	4.06	4.60	0.160	0.181
C	2.29	2.83	0.090	0.111
D	1.99	2.50	0.078	0.098
E	0.90	1.41	0.035	0.056
F	4.95	5.33	0.195	0.210
G	0.10	0.20	0.004	0.008
H	0.15	0.31	0.006	0.012

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
A	1.68	0.066
B	1.52	0.060
C	3.93	0.155
D	2.41	0.095
E	5.45	0.215

MARKING DIAGRAM



P/N = Specific Device Code
G = Green Compound
YW = Date Code
F = Factory Code

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